GP2S09/GP2S24/ GP2S26/GP2S27

Subminiature Photointerrupter

(Unit: mm)

■ Features

1. Compact and thin

GP2S09: Compact DIP long lead type

GP2S24: Compact DIP type **GP2S26**: Flat lead type

GP2S27: Mini-flat package type

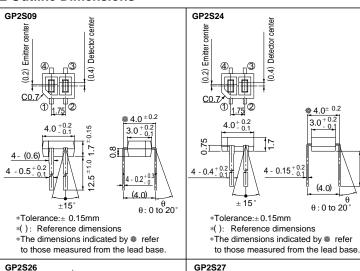
2. Optimum detection distance: 0.6 to 0.8mm

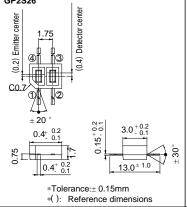
3. Visible light cut-off type

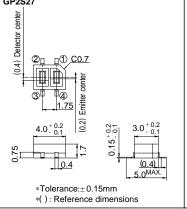
■ Applications

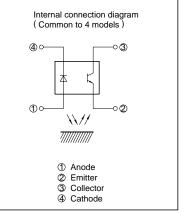
- 1. Cassette tape recorders, VCRs
- 2. Floppy disk drives
- 3. Various microcomputerized control equipment

■ Outline Dimensions









■ Absolute Maximum Ratings

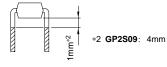
(Ta	=	25°	C)

Parameter		Symbol	Rating	Unit	
	Forward current	I_{F}	50	mA	
Input	Reverse voltage	V _R	6	V	
	Power dissipation	P	75	mW	
	Collector-emitter voltage	V _{CEO}	35	V	
Output Collector c	Emitter-collector voltage	V _{ECO}	6	V	
	Collector current	$I_{\rm C}$	20	mA	
	Collector power dissilpation	Pc	75	mW	
	Total power dissipation	P _{tot}	100	mW	
	Operating temperature		- 20 to + 85	°C	
	Storage temperature	T _{stg}	- 40 to + 100	°C	
	*1Soldering temperature	T _{sol}	260	°C	

^{*1} Within 5 seconds (Soldering areas for each model are shown below)

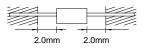
GP2S09, GP2S24

Soldering area: The hatched area more than 1mm*² away from the lower edge of package as shown in the figure below.



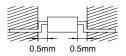
GP2S26

Soldering area: The hatched area more than 2.0mm away from the both edges of package as shown in the figure below.



GP2S27

Soldering area
The hatched area more than
0.5mm away from the both
edges of package as shown
in the figure below.



■ Electro-optical Characteristics

 $(Ta = 25^{\circ}C)$

	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Immust	Forward voltage		$V_{\rm F}$	$I_F = 20 \text{mA}$	-	1.2	1.4	V
Input	Reverse current		I_R	$V_R = 6V$	-	-	10	μΑ
Output	Collector dark curre	ent	ICEO	$V_{\text{CE}} = 20V$	-	10- 9	10 -7	Α
	*3Collector current		I_{C}	$I_F=4mA,\ V_{CE}=2V$	20	45	120	μΑ
Transfer	Doomonoo timo	Rise time	$t_{\rm r}$	$V_{\text{CE}}=2V,I_{\text{C}}=100\mu$ A	-	20	100	μs
charac- teristics	Response time	Fall time	t_{f}	$R_{\rm L}=1k\Omega$, $d=1mm$	-	20	100	μs
	*4Leak current		ILEAK	$I_F=4mA,\ V_{CE}=2V$	-	-	0.1	μΑ

^{*3} The condition and arrangement of the reflective object are shown below.

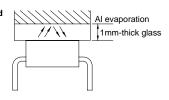
The ranking of collector current shall be classified into the following 6 ranks.

(GP2S09, GP2S24, GP2S26, GP2S27)

Rank	Collector-current I C (µ A)
*5A	20 to 42
В	34 to 71
C	58 to 120
A or B	20 to 71
B or C	34 to 120
A, B or C	20 to 120

^{*5} GP2S24 and GP2S26 and GP2S27 don't have A rank.

Test Condition and Arrangement for Collector Current



^{*4} Without reflective object

Fig. 1 Forward Current vs.

Ambient Temperature

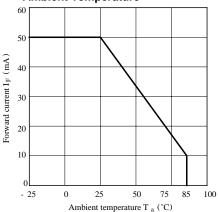


Fig. 3 Forward Current vs. Forward Voltage

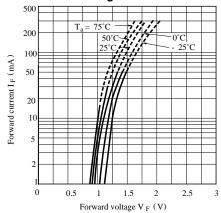


Fig. 5 Collector Current vs.
Collector-Emitter Voltage

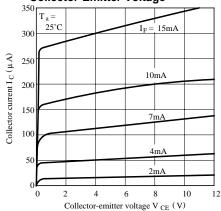


Fig. 2 Power Dissipation vs.
Ambient Temperature

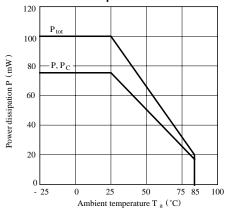


Fig. 4 Collector Current vs. Forward Current

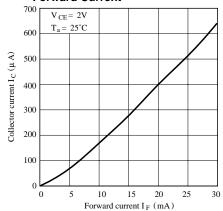


Fig. 6 Relative Collector Current vs.

Ambient Temperature

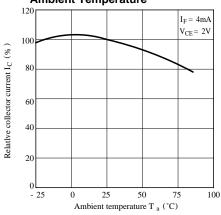


Fig. 7 Collector Dark Current vs.
Ambient Temperature

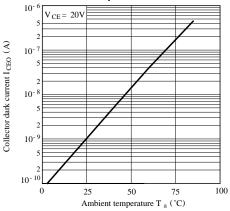


Fig. 9 Response Time vs. Load Resistance (GP2S24/ GP2S26/GP2S27)

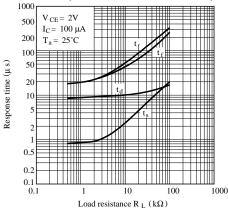


Fig.10 Relative Collector Current vs.
Distance between Sensor and
Al Evaporation Glass

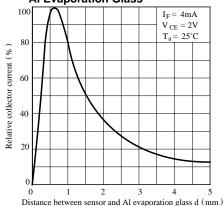
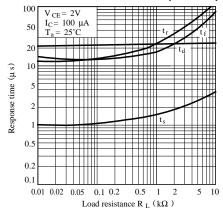


Fig. 8 Response Time vs. Load Resistance (GP2S09)



Test Circuit for Response Time

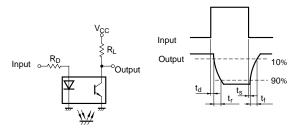


Fig.11 Relative Collector Current vs.
Card Moving Distance (1)

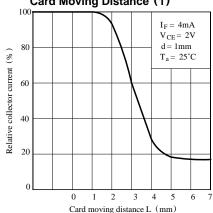


Fig.12 Relative Collector Current vs.
Card Moving Distance (2)

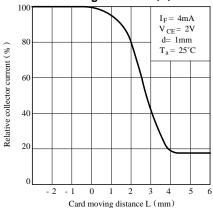


Fig.13-a Frequency Response (GP2S09)

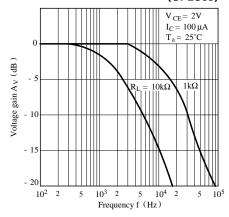
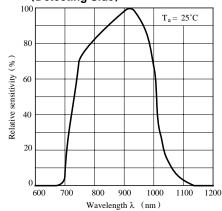


Fig.14 Spectral Sensitivity (Detecting Side)



Test Condition for Distance & Detecting Position Characteristics (EX: GP2S24)

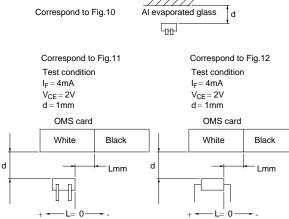
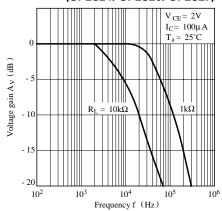


Fig.13-b Frequency Response (GP2S24/ GP2S26/ GP2S27)



• Please refer to the chapter "Precautions for Use".

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